

# HAT2029R

Silicon N Channel Power MOS FET  
High Speed Power Switching

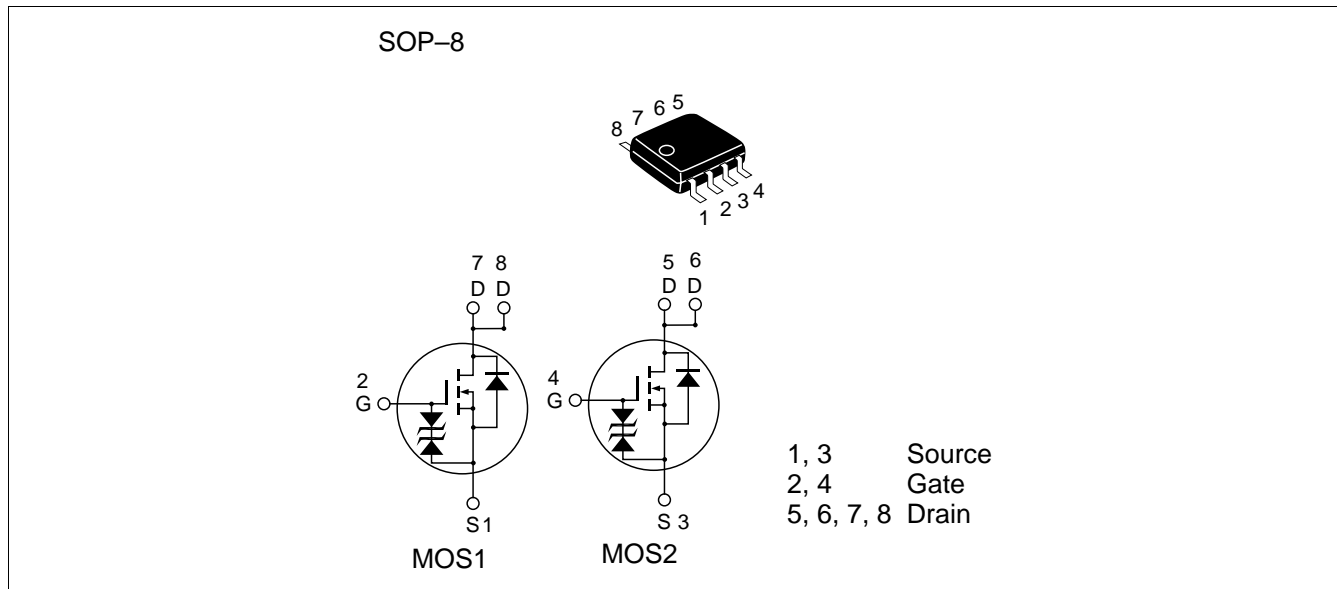
# HITACHI

ADE-208-525D (Z)  
5th. Edition  
February 1999

## Features

- Low on-resistance
- Capable of 2.5 V gate drive
- Low drive current
- High density mounting

## Outline



## Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Ratings	Unit
Drain to source voltage	$V_{DSS}$	28	V
Gate to source voltage	$V_{GSS}$	$\pm 12$	V
Drain current	$I_D$	7.5	A
Drain peak current	$I_{D(pulse)}$ <sup>Note1</sup>	60	A
Body-drain diode reverse drain current	$I_{DR}$	7.5	A
Channel dissipation	Pch <sup>Note2</sup>	2	W
Channel dissipation	Pch <sup>Note3</sup>	3	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	- 55 to + 150	°C

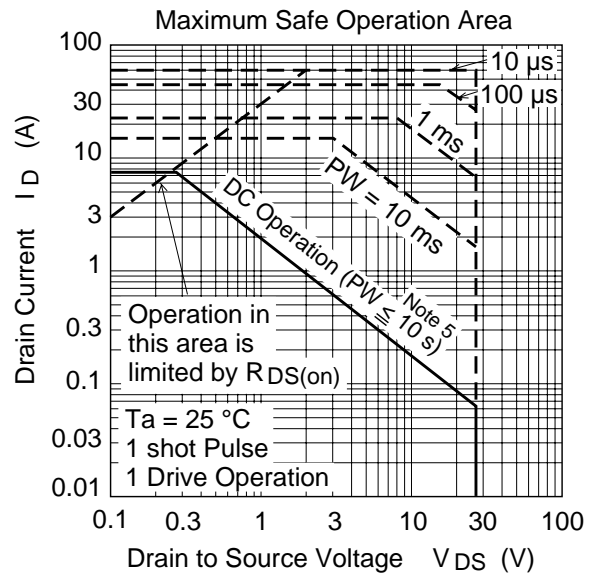
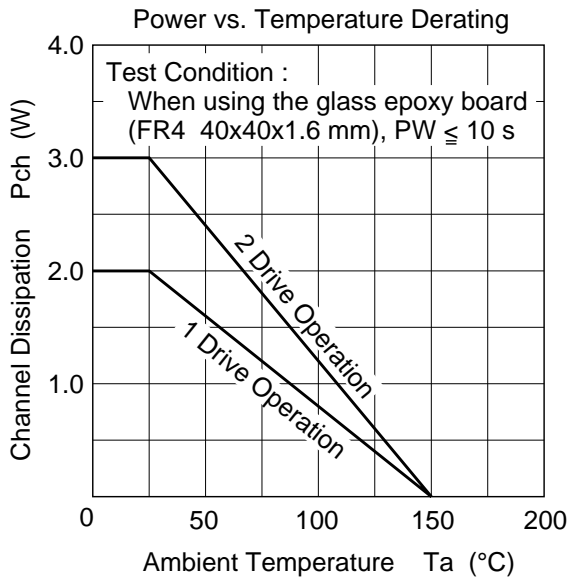
Note: 1.  $PW \leq 10\mu s$ , duty cycle  $\leq 1\%$   
 2. 1 Drive operation : When using the glass epoxy board (FR4 40 x 40 x 1.6 mm),  $PW \leq 10s$   
 3. 2 Drive operation : When using the glass epoxy board (FR4 40 x 40 x 1.6 mm),  $PW \leq 10s$

## Electrical Characteristics (Ta = 25°C)

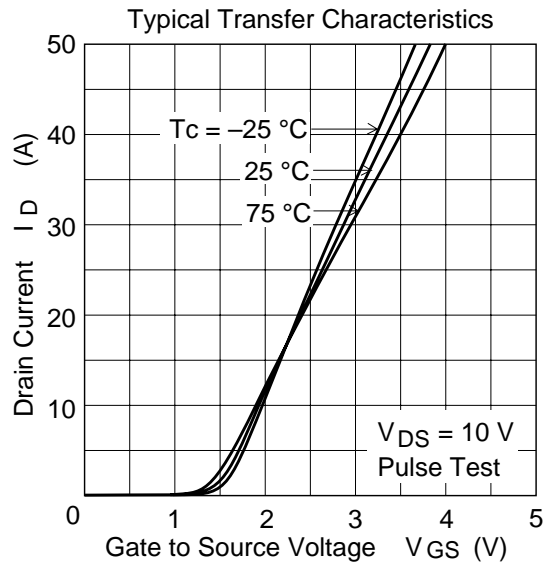
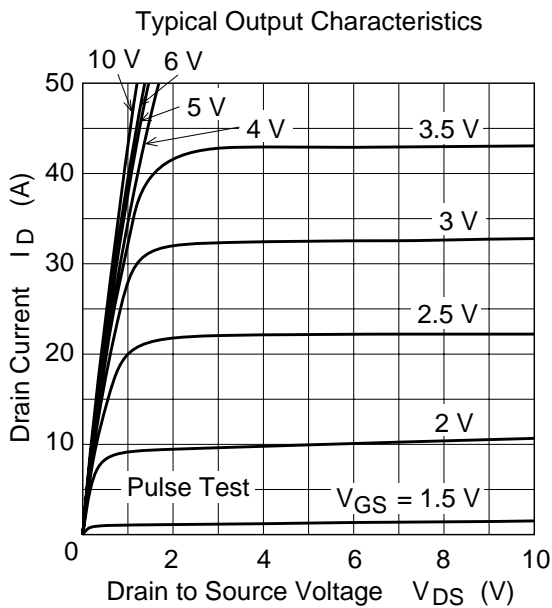
Item	Symbol	Min	Typ	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	28	—	—	V	$I_D = 10\text{ mA}$ , $V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	$\pm 12$	—	—	V	$I_G = \pm 100\ \mu A$ , $V_{DS} = 0$
Gate to source leak current	$I_{GSS}$	—	—	$\pm 10$	$\mu A$	$V_{GS} = \pm 10\text{ V}$ , $V_{DS} = 0$
Zero gate voltage drain current	$I_{DSS}$	—	—	1	$\mu A$	$V_{DS} = 28\text{ V}$ , $V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	0.4	—	1.4	V	$V_{DS} = 10\text{ V}$ , $I_D = 1\text{ mA}$
Static drain to source on state resistance	$R_{DS(on)}$	—	0.025	0.033	$\Omega$	$I_D = 4\text{ A}$ , $V_{GS} = 4\text{ V}$ <sup>Note4</sup>
	$R_{DS(on)}$	—	0.031	0.043	$\Omega$	$I_D = 4\text{ A}$ , $V_{GS} = 2.5\text{ V}$ <sup>Note4</sup>
Forward transfer admittance	$ y_{fs} $	9.5	15	—	S	$I_D = 4\text{ A}$ , $V_{DS} = 10\text{ V}$ <sup>Note4</sup>
Input capacitance	Ciss	—	780	—	pF	$V_{DS} = 10\text{ V}$
Output capacitance	Coss	—	470	—	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	—	190	—	pF	$f = 1\text{ MHz}$
Turn-on delay time	$t_{d(on)}$	—	20	—	ns	$V_{GS} = 4\text{ V}$ , $I_D = 4\text{ A}$
Rise time	$t_r$	—	170	—	ns	$V_{DD} \cong 10\text{ V}$
Turn-off delay time	$t_{d(off)}$	—	140	—	ns	
Fall time	$t_f$	—	170	—	ns	
Body-drain diode forward voltage	$V_{DF}$	—	0.88	1.15	V	$I_F = 7.5\text{ A}$ , $V_{GS} = 0$ <sup>Note4</sup>
Body-drain diode reverse recovery time	$t_{rr}$	—	65	—	ns	$I_F = 7.5\text{ A}$ , $V_{GS} = 0$ $diF/dt = 20\text{ A}/\mu s$

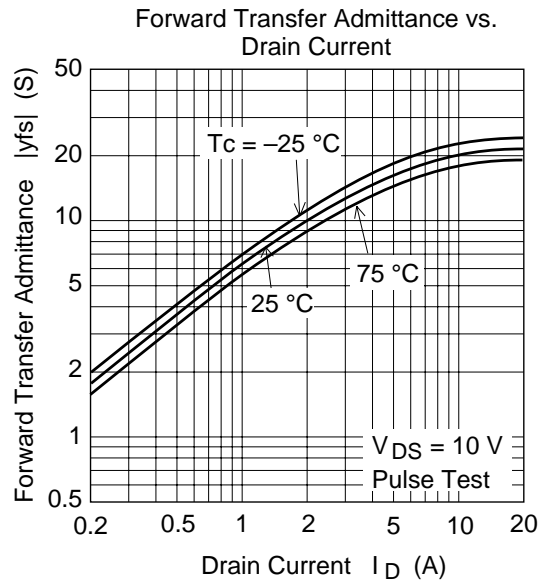
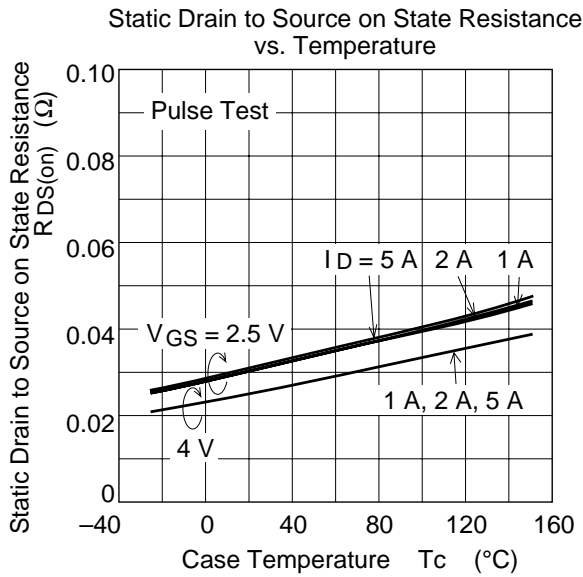
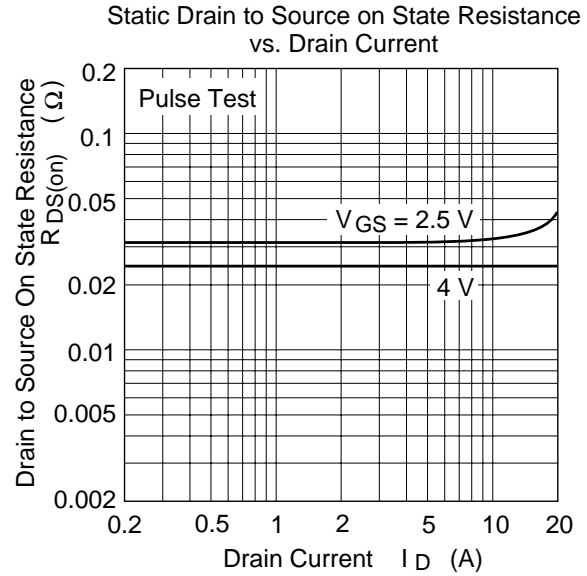
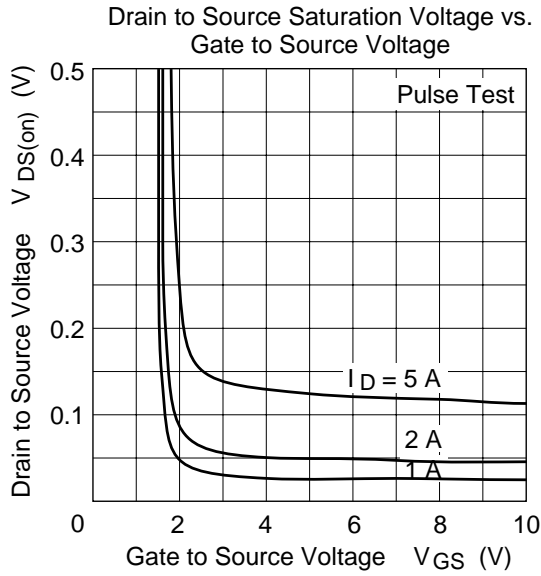
Note: 4. Pulse test

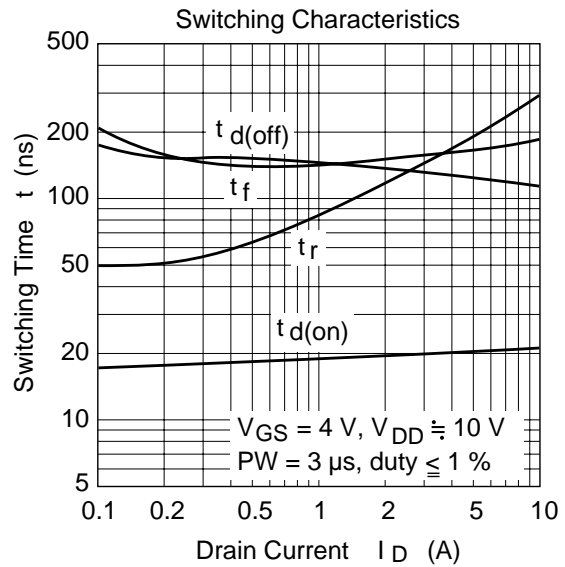
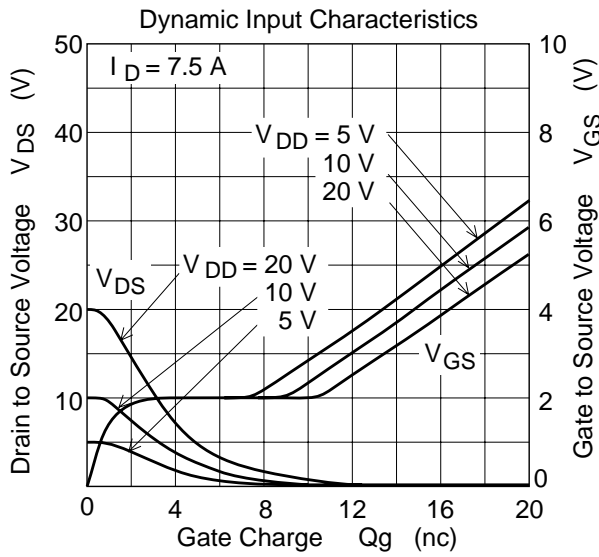
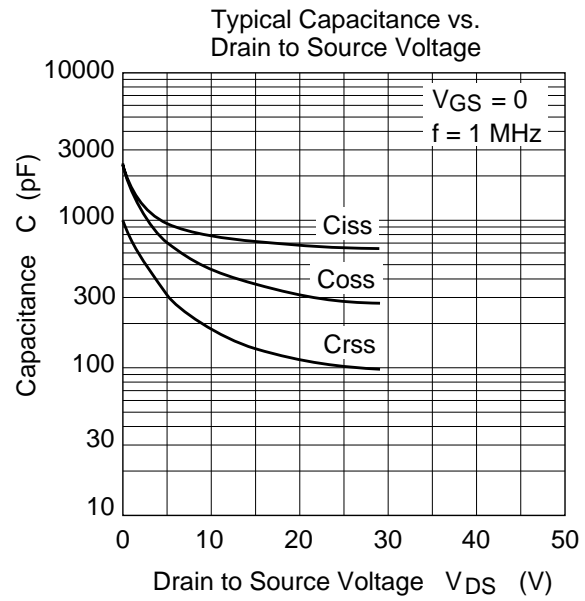
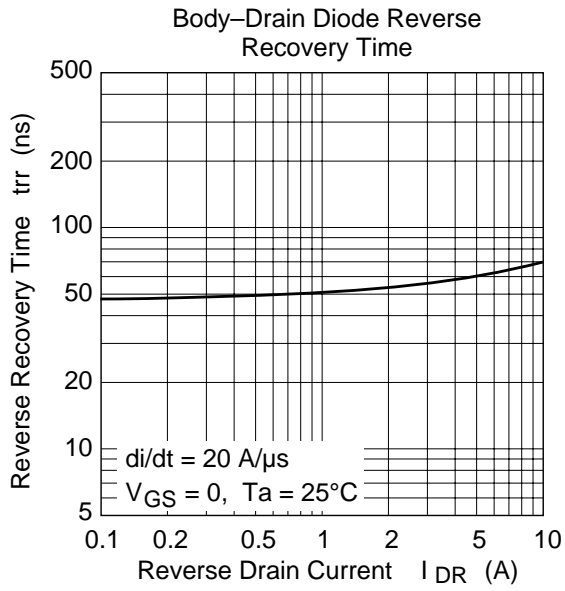
Main Characteristics

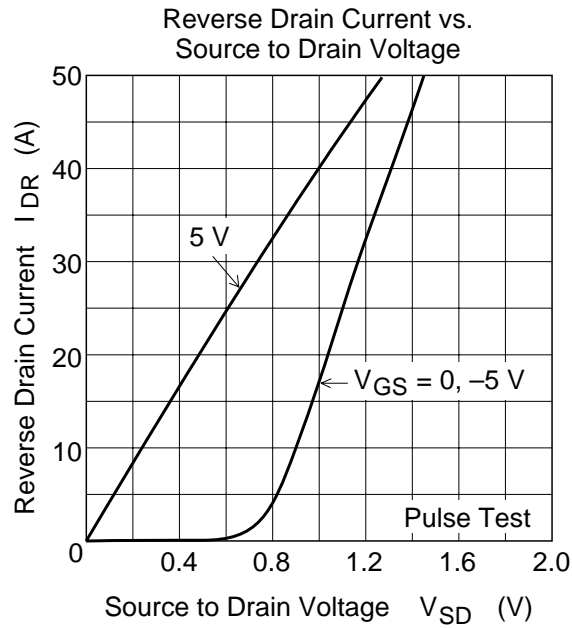


Note 5 :  
When using the glass epoxy board (FR4 40x40x1.6 mm)

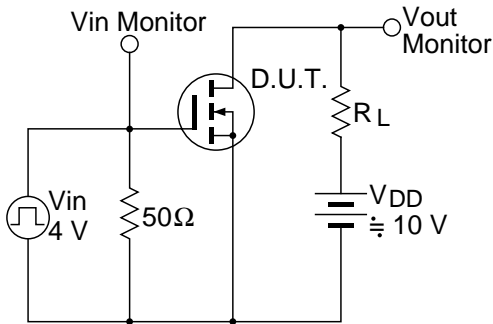




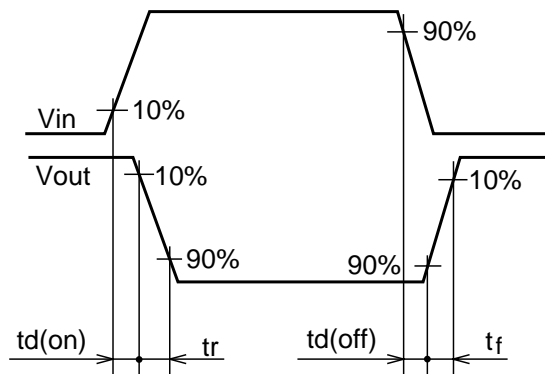


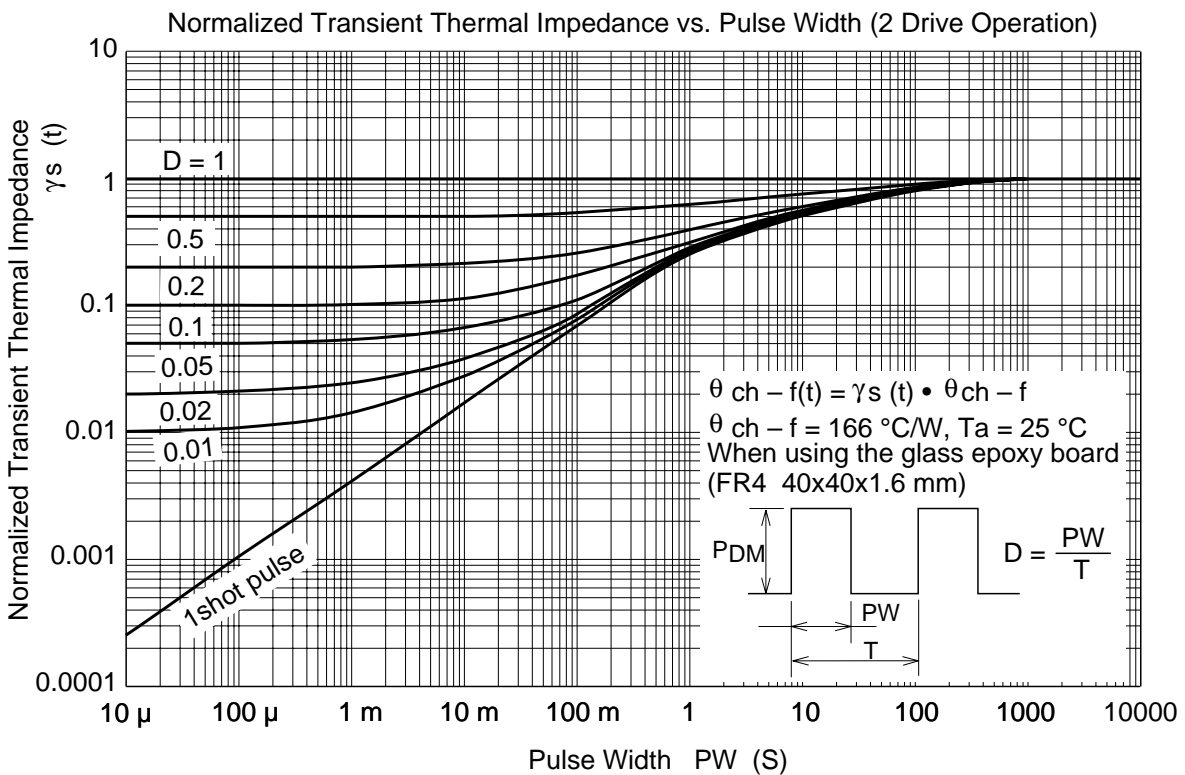
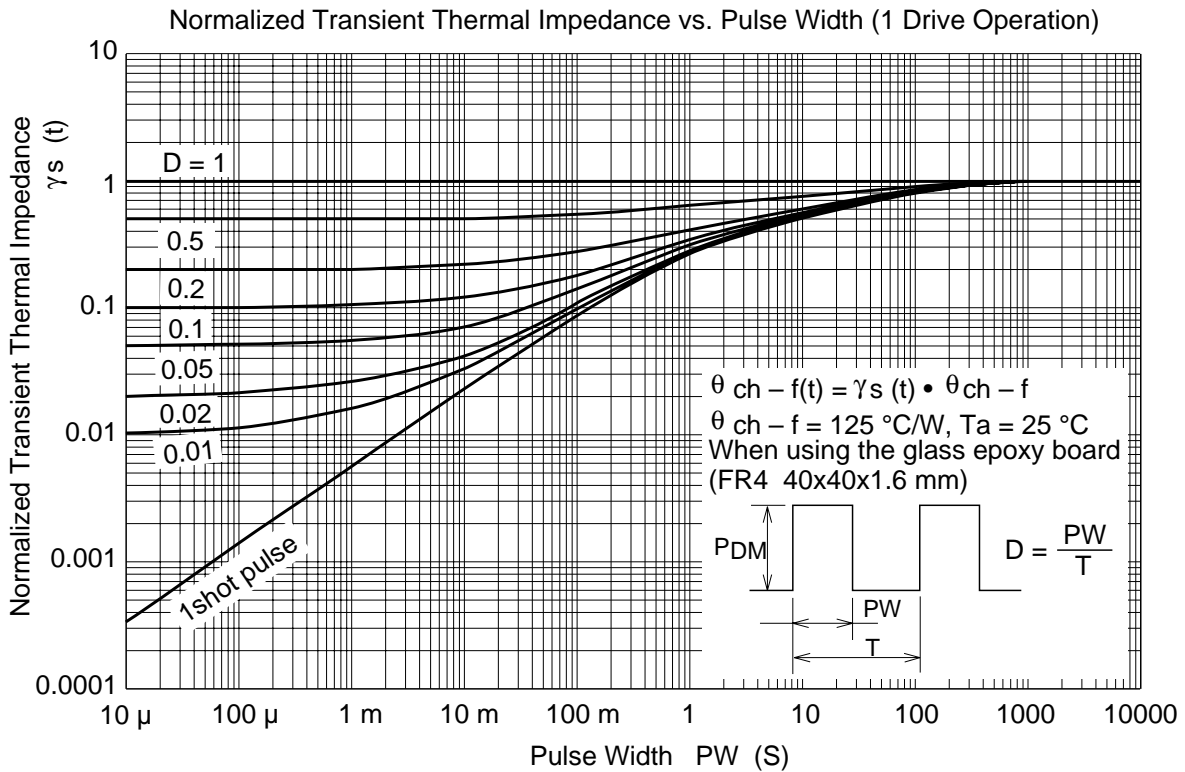


Switching Time Test Circuit



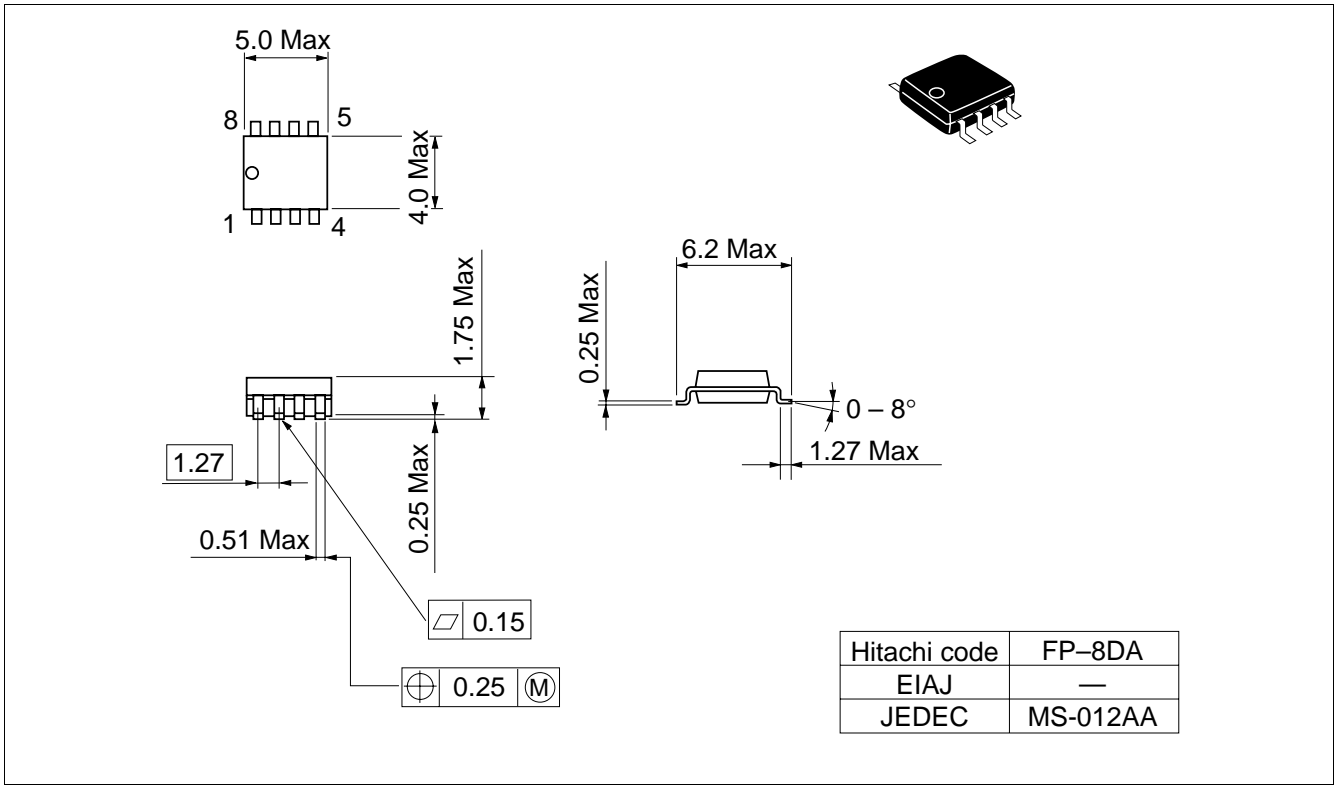
Switching Time Waveform





## Package Dimensions

Unit: mm





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